NSN 5962-01-123-2000



Memory Microcircuit - Page 1 of 2 View Online at https://aerobasegroup.com/nsn/5962-01-123-2000 **Overall Height:** 0.350 inches **Body Length:** Between 0.890 inches and 0.930 inches **Body Width:** Between 0.280 inches and 0.310 inches **Body Height:** Between 0.080 inches and 0.120 inches **Maximum Power Dissipation Rating:** 409.6 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and burn in and programmable and bipolar and w/enable **Inclosure Material:** Ceramic **Inclosure Configuration:** Flat pack **Output Logic Form:** Transistor-transistor logic **Input Circuit Pattern:** 12 input **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** 7.0 volts power source **Time Rating Per Chacteristic:** 125.00 nanoseconds propagation delay time, low to high level output and 125.00 nanoseconds propagation delay time, high to low level output **Memory Device Type:** Rom **Memory Capacity:** Unknown **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:**

N/a

18 flat leads Shelf Life:

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

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